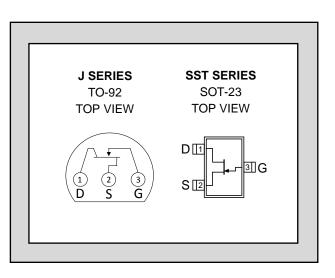
LINEAR SYSTEMS

Improved Standard Products[®]

FEATURES						
DIRECT REPLACEMENT FOR SILICONIX J/SST111 SERIES						
LOW GATE LEAKAGE CURRENT	5pA					
FAST SWITCHING	4ns					
ABSOLUTE MAXIMUM RATINGS ¹						
@ 25 °C (unless otherwise stated)						
Maximum Temperatures						
Storage Temperature	-55 to 150°C					
Junction Operating Temperature	-55 to 150°C					
Maximum Power Dissipation						
Continuous Power Dissipation (J) ³	360mW					
Continuous Power Dissipation (SST) ³	350mW					
Maximum Currents						
Gate Current	50mA					
Maximum Voltages						
Gate to Drain	-35V					
Gate to Source	-35V					

J/SST111 SERIES

SINGLE N-CHANNEL JFET SWITCH



STATIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC	ТҮР	J/SS	T111	J/SS	T112	J/SS	T113	UNIT		
5 T M.	CHARACTERISTIC	ITP	MIN	MAX	MIN	MAX	MIN	MAX	UNIT	CONDITIONS	
BV _{GSS}	Gate to Source Breakdown Voltage		-35		-35		-35			$I_G = -1\mu A$, $V_{DS} = 0V$	
V _{GS(off)}	Gate to Source Cutoff Voltage		-3	-10	-1	-5		-3	V	$V_{DS} = 5V, I_D = 1\mu A$	
V _{GS(F)}	Gate to Source Forward Voltage	0.7								$I_G = 1mA$, $V_{DS} = 0V$	
IDSS	Drain to Source Saturation Current ²		20		5		2		mA	$V_{DS} = 15V, V_{GS} = 0V$	
I _{GSS}	Gate Leakage Current	-0.005		-1		-1		-1	nA	$V_{GS} = -15V, \ V_{DS} = 0V$	
lg	Gate Operating Current	-5							pА	$V_{DG} = 15V, I_D = 1.0mA$	
I _{D(off)}	Drain Cutoff Current	0.005		1		1		1	nA	$V_{DS} = 5V, V_{GS} = -10V$	
f DS(on)	Drain to Source On Resistance			30		50		100	Ω	$V_{GS} = 0V, V_{DS} = 0.1V$	

DYNAMIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

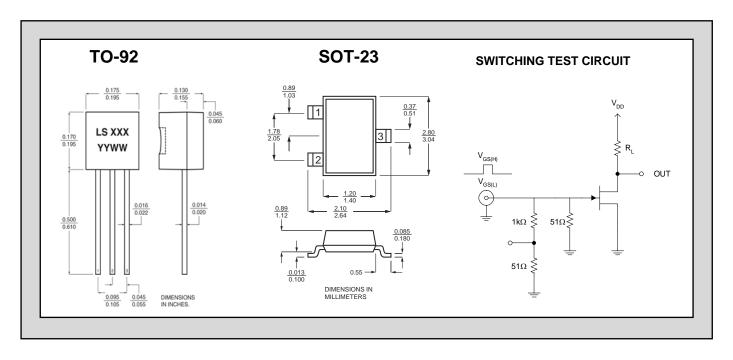
SYM.	CHARACTERISTIC	ТҮР	J/SST111		J/SST112		J/SST112		J/SST113		LINUT	CONDITIONS
5111.	CHARACTERISTIC	ITP	MIN	MAX	MIN	MAX	MIN	MAX	UNIT	CONDITIONS		
g _{fs}	Forward Transconductance	6							mS	$V_{DS} = 20V, I_D = 1mA$		
gos	Output Conductance	25							μS	f = 1kHz		
r ds(on)	Drain to Source On Resistance			30		50		100	Ω	$V_{GS} = 0V, I_D = 1mA$ f = 1kHz		
Ciss	Input Capacitance	7		12		12		12	~ Г	$V_{DS} = 0V, V_{GS} = -10V$		
Crss	Reverse Transfer Capacitance	3		5		5		5	pF	f = 1 MHz		
en	Equivalent Noise Voltage	3							nV/√Hz	$V_{DG} = 10V, I_D = 1mA$ f = 1 kHz		

SWITCHING CHARACTERISTICS

SYM.	CHARACTERISTIC	TYP	UNIT	CONDITIONS
t _{d(on)}	Turn On Time	2	ns	$\begin{array}{l} V_{DD}=10V\\ V_{GS(H)}=0V \end{array}$
tr	rum On Time	2		
t _{d(off)}	Turn Off Time	6		
t _f		15		

SWITCHING CIRCUIT CHARACTERISTICS

SYM.	J/SST111	J/SST112	J/SST113
V _{GS(L)}	-12V	-7V	-5V
R∟	800Ω	1600Ω	3200Ω
I _{D(on)}	12mA	6mA	3mA



NOTES

- 1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 2. Pulse test: PW \leq 300µs, Duty Cycle \leq 3%
- 3. Derate 2.8mW/°C above 25°C

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